



#### 3.0A GLASS PASSIVATED BRIDGE RECTIFIER

## Product Summary (@TA = +25°C)

V <sub>RRM</sub> (V)	I <sub>O</sub> MAX (A)	V <sub>F</sub> MAX (V)	I <sub>R</sub> MAX (μ <b>A</b> )	
400, 600, 800, 1000	3	1.1	5	

### **Features and Benefits**

- Glass Passivated Die Construction
- High Case Dielectric Strength of 1000 PRV
- Low Reverse Leakage Current
- Surge Overload Rating to 90A Peak
- Ideal for Printed Circuit Board Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)

## **Description and Applications**

Suitable for AC to DC bridge full wave rectification for AC/DC Power Supply, LED lighting, home appliances, office equipment, and telecommunication applications.

### **Mechanical Data**

- Case: KBP
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Tin. Plated Leads, Solderable per MIL-STD-202, Method 208
- Polarity: Marked on Body
- Weight: 1.52 grams (Approximate)

#### **KBP**



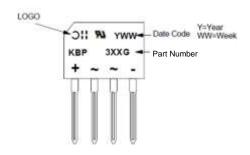
## Ordering Information (Note 3)

Part Number	Compliance	Case	Packaging
KBP304G	Commercial	KBP	35 Pieces per Tube
KBP306G	Commercial	KBP	35 Pieces per Tube
KBP308G	Commercial	KBP	35 Pieces per Tube
KBP310G	Commercial	KBP	35 Pieces per Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- $3. \ For packaging \ details, go \ to \ our \ website \ at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

## **Marking Information**





## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	KBP304G	KBP306G	KBP308G	KBP310G	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	400	600	800	1000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	280	420	560	700	V
Average Rectified Output Current (With Heatsink)  @T <sub>C</sub> = +105°C (Without Heatsink)	Io		_	.0 .9		А
Non-Repetitive Peak Forward Surge Current $@T_J = +25^{\circ}\text{C}$ 8.3ms Single Half Sine-Wave Superimposed on Rated Load $@T_J = +125^{\circ}\text{C}$	I <sub>FSM</sub>	90 80				А
Non-Repetitive Peak Forward Surge Current @ $T_J = +25^{\circ}$ C 1.0ms Single Half Sine-Wave Superimposed on Rated Load @ $T_J = +125^{\circ}$ C	I <sub>FSM</sub>			30 60		Α
$I^2t$ Rating for Fusing (3ms $\leq$ t $\leq$ 8.3ms)	l <sup>2</sup> t		26	6.5		A²s

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 4)	$R_{ heta JC}$	10	°C/W
Typical Thermal Resistance, Junction to Lead (Note 4)	$R_{ heta JL}$	12	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 4)	$R_{\theta JA}$	30	°C/W
Typical Thermal Resistance, Junction to Case (Note 5)	R <sub>eJC</sub>	12	°C/W
Typical Thermal Resistance, Junction to Lead (Note 5)	$R_{ heta JL}$	18	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	40	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min		Min		Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	1,000	KBP310G	_	_	V	I <sub>R</sub> = 5µA		
		800	KBP308G						
The residual Disastration of	* (DK)K	600	KBP306G				ΙΚ – Ομ. τ		
		400	KBP304G						
Forward Voltage Drop per Element	VF	_		0.91	1.1	V	I <sub>F</sub> = 3A, T <sub>J</sub> = +25°C		
Lookaga Current (Nota 6)	I <sub>R</sub>			_	5		$V_R = V_{RRM}, T_J = +25$ °C		
Leakage Current (Note 6)			_	-	500	μA	$V_R = V_{RRM}, T_J = +125$ °C		
Total Capacitance per Element	Ст	_		_		35	_	pF	$V_R = 4.0V_{DC}$ , $f = 1MHz$

Notes: 4. Thermal resistance from junction to case per element. Device mounted on 30mm x 30mm x 1mm Cu Plate Heatsink.

5. Thermal resistance from junction to case per element without heat sink.6. Short duration pulse test used to minimize self-heating effect.



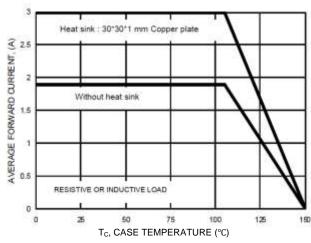
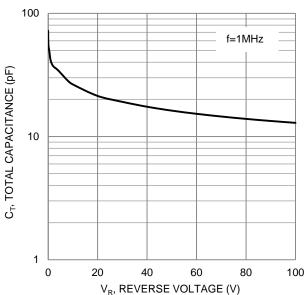
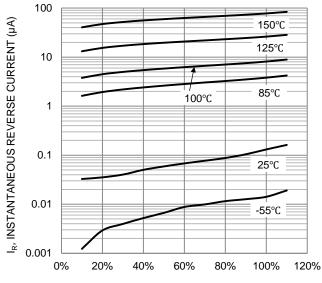


Figure 1. Forward Current Derating Curve



V<sub>R</sub>, REVERSE VOLTAGE (V) Figure 3. Typical Total Capacitance (Per Element)



V<sub>R</sub>, RATED PEAK REVERSE VOTLAGE (V) Figure 5. Typical Reverse Characteristics

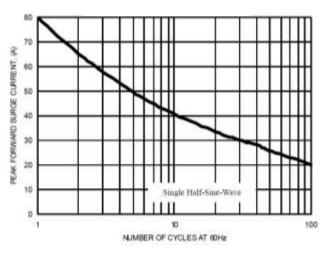
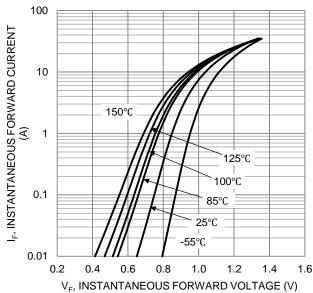


Figure 2. Maximum Non-repetitive Surge Current



V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE ( Figure 4. Typical Forward Characteristics

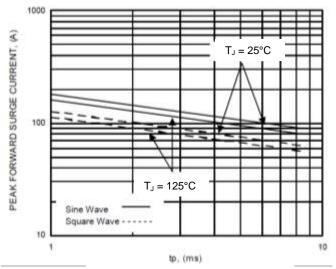


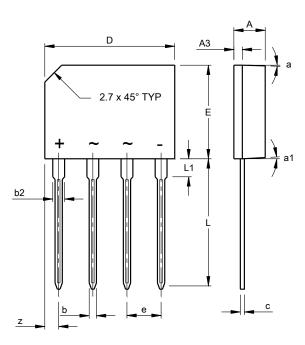
Figure 6. Non-repetitive Surge Current



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

KBP



КВР						
Dim	Min	Max	Тур			
Α	3.35	3.65	-			
A3	0.80	1.10	-			
b	0.76	0.86	-			
b2	1.22	1.42	-			
C	0.35	0.55	-			
D	14.25	14.75	-			
Е	10.20	10.60	-			
е	3.56	4.06	-			
ш	14.25	14.73	-			
L1	1.80	2.20	-			
Z	1.40	1.70	-			
а	-	-	3°			
a1	-	-	2°			
All Dimensions in mm						



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